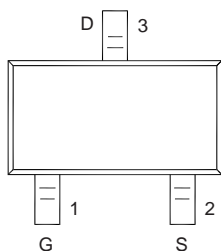


## N-Channel 600 V (D-S) MOSFET

### PRODUCT SUMMARY

$V_{DS}$ (V)	$R_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
600	80 at $V_{GS} = 10$ V	0.15

(SOT-23-3L)



### FEATURES

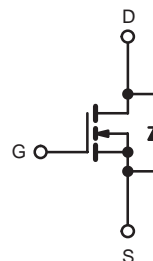
- DT-Trench Power MOSFET
- 100%  $R_g$  and UIS Tested

### APPLICATIONS

- High efficient switched mode power supplies
- TV Power
- Adapter/charger



**RoHS**  
COMPLIANT



N-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	600	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 175^\circ\text{C}$ ) <sup>a</sup>	$I_D$	$T_A = 25^\circ\text{C}$ 0.15	A
		$T_A = 70^\circ\text{C}$ 0.13	
Pulsed Drain Current	$I_{DM}$	0.6	
Avalanche Current	$I_{AS}$	0.12	
Peak diode recovery $dv/dt$	$dv/dt$	6	V/ns
Maximum Power Dissipation <sup>a</sup>	$P_D$	$T_A = 25^\circ\text{C}$ 2.5	W
		$T_A = 70^\circ\text{C}$ 1.86	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to 150	$^\circ\text{C}$

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	$R_{thJA}$	$t \leq 10$ s 55	115	$^\circ\text{C/W}$
		Steady State 38	85	
Maximum Junction-to-Foot (Drain)	$R_{thJF}$	12	28	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

**SPECIFICATIONS**  $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted

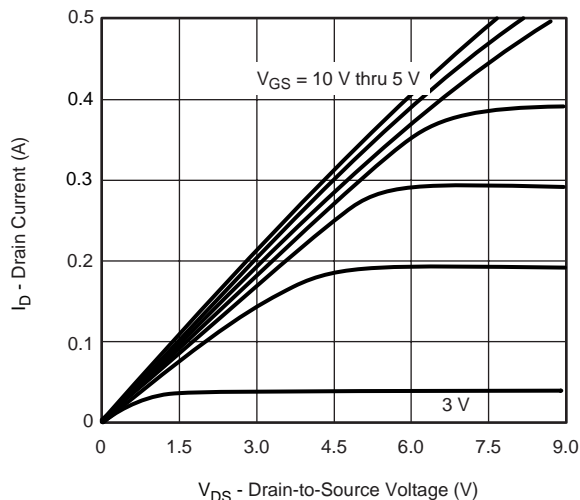
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	600			V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$		0.6		V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2		4	V
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
		$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^{\circ}\text{C}$			10	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = 5\text{ V}, V_{GS} = -10\text{ V}$	19			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 0.02\text{ A}$		80	120	$\Omega$
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 40\text{ V}, I_D = 0.02\text{ A}$		0.22		S
Dynamic <sup>b</sup>						
Input Capacitance	$C_{iss}$	$V_{DS} = 300\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$		73		pF
Output Capacitance	$C_{oss}$			12		
Reverse Transfer Capacitance	$C_{rss}$			5		
Total Gate Charge	$Q_g$	$V_{DS} = 300\text{ V}, V_{GS} = 10\text{ V}, I_D = 0.02\text{ A}$		3.9		nC
Gate-Source Charge	$Q_{gs}$			0.28		
Gate-Drain Charge	$Q_{gd}$			2.6		
Gate Resistance	$R_g$	$f = 1\text{ MHz}$		6.5		$\Omega$
Turn-On Delay Time	$t_{d(on)}$	$V_{DS} = 300\text{ V}, R_L = 15\text{ }\Omega$ $I_D \cong 0.02\text{ A}, V_{GS} = 10\text{ V}, R_g = 1\text{ }\Omega$		7		ns
Rise Time	$t_r$			15		
Turn-Off Delay Time	$t_{d(off)}$			18		
Fall Time	$t_f$			52		
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25\text{ }^{\circ}\text{C}$			0.15	A
Pulse Diode Forward Current <sup>a</sup>	$I_{SM}$				0.6	
Body Diode Voltage	$V_{SD}$	$I_S = 0.15\text{ A}$		0.8	1.2	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 0.15\text{ A}, dI/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^{\circ}\text{C}$		152		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			165		nC

Notes:

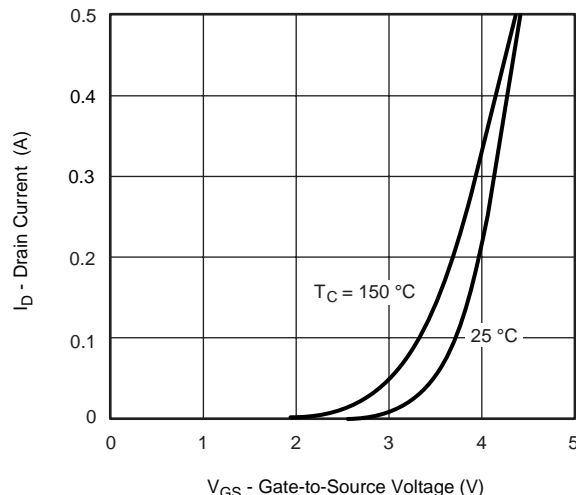
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .  
 b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

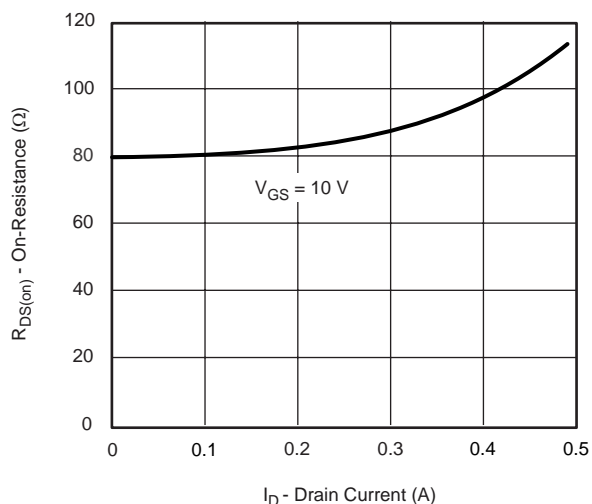
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



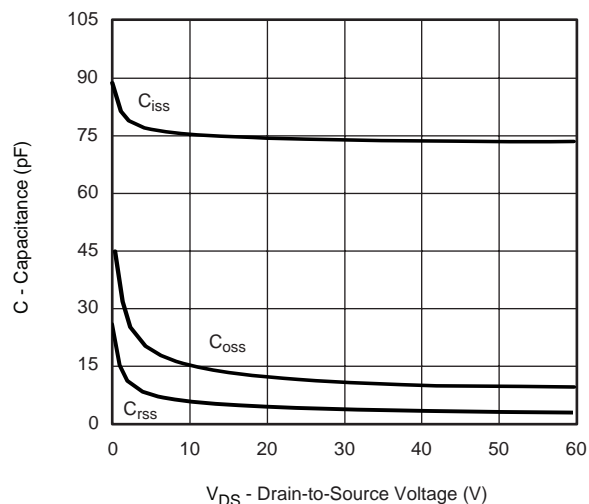
**Output Characteristics**



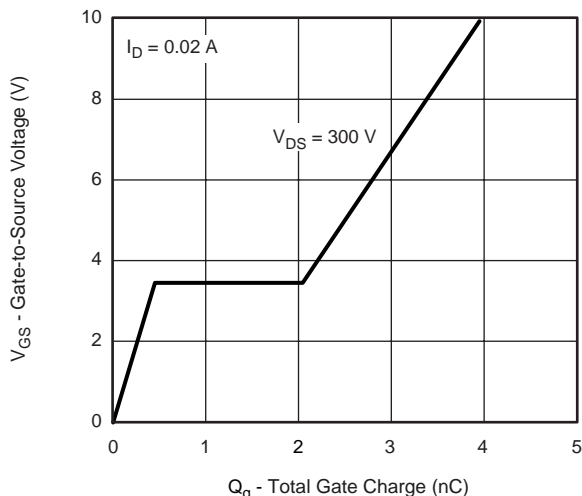
**Transfer Characteristics**



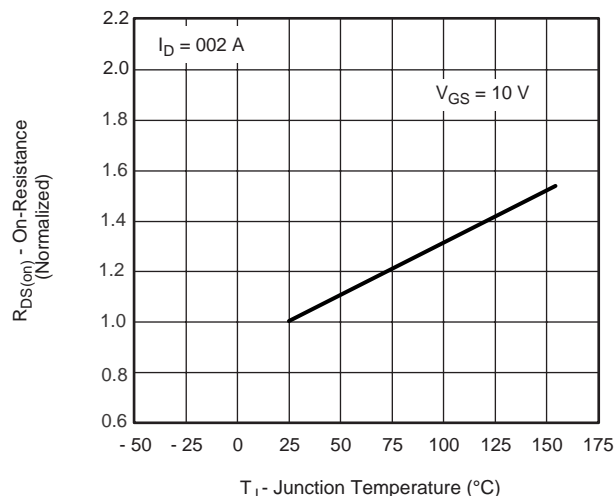
**On-Resistance vs. Drain Current**



**Capacitance**

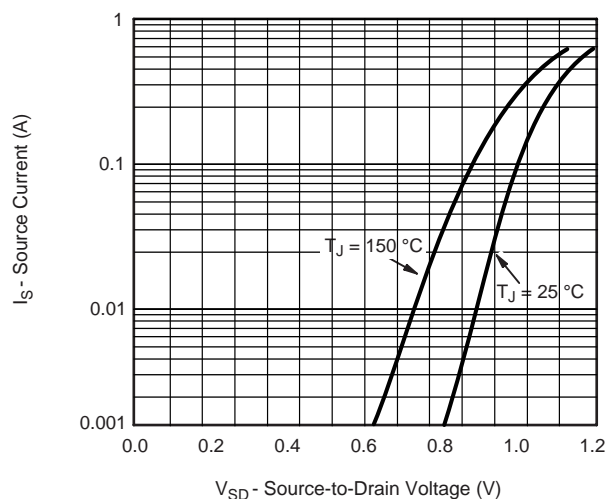


**Gate Charge**

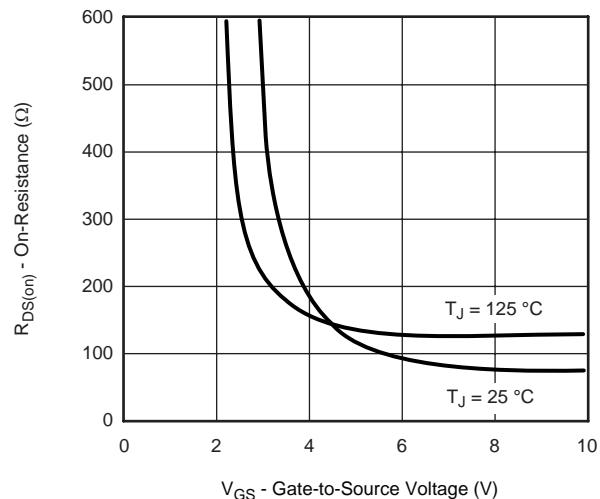


**On-Resistance vs. Junction Temperature**

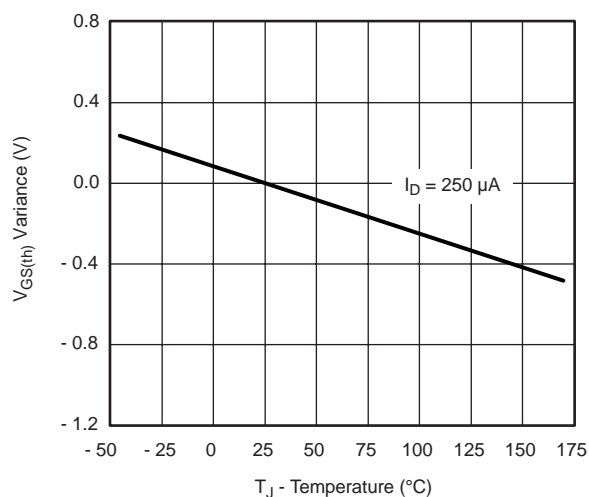
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



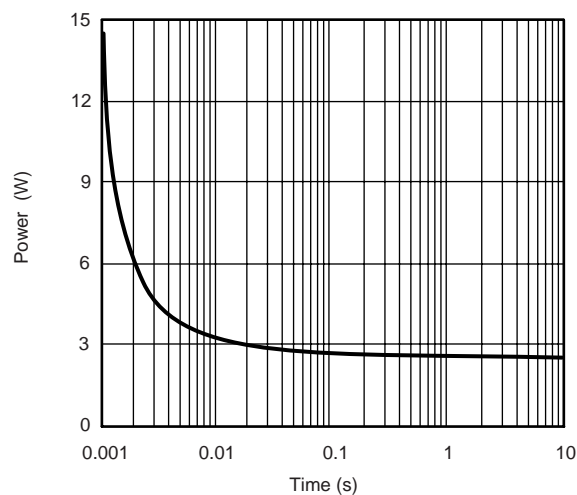
**Source-Drain Diode Forward Voltage**



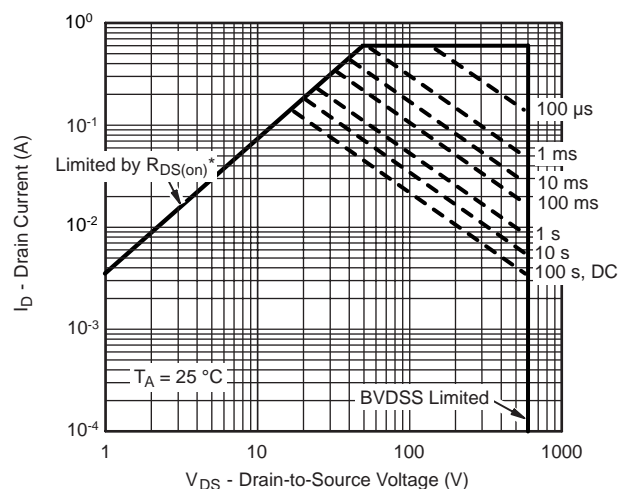
**On-Resistance vs. Gate-to-Source Voltage**



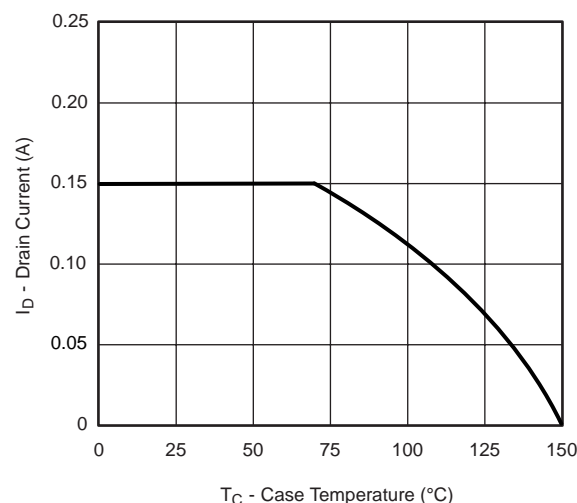
**Threshold Voltage**



**Single Pulse Power, Junction-to-Ambient**

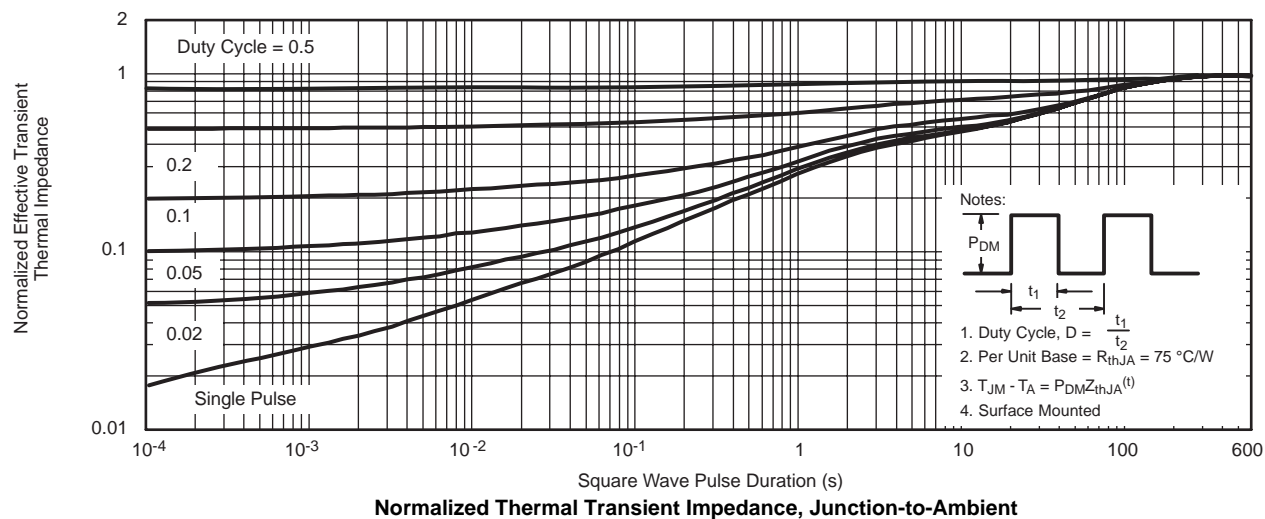


**Safe Operating Area, Junction-to-Ambient**  
\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



**Current Derating\***

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150\text{ }^{\circ}\text{C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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